74HCU04-Q100

Hex unbuffered inverter

Rev. 3 — 16 July 2020

Product data sheet

1. General description

The 74HCU04-Q100 is a hex unbuffered inverter. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of $V_{\rm CC}$.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 6.0 V
- · CMOS low power dissipation
- High noise immunity
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- · Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- · Balanced propagation delays
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)
- Multiple package options
- DHVQFN package with Side-Wettable Flanks enabling Automatic Optical Inspection (AOI) of solder joints

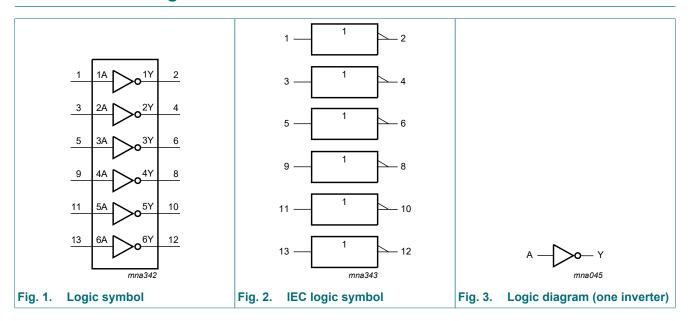
3. Ordering information

Table 1. Ordering information

Type number	Package	Package												
	Temperature range	Name	Description	Version										
74HCU04D-Q100	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1										
74HCU04PW-Q100	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1										
74HCU04BQ-Q100	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1										

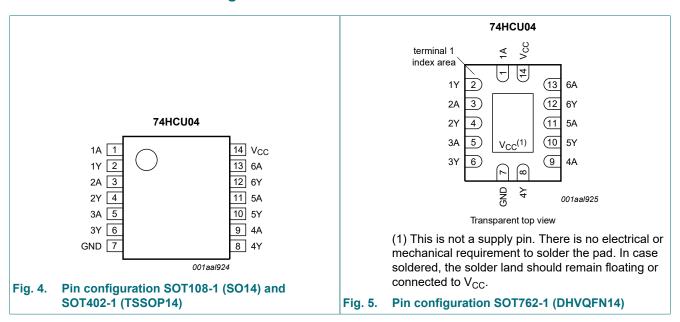


4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1A, 2A, 3A, 4A, 5A, 6A	1, 3, 5, 9, 11, 13	data input
1Y, 2Y, 3Y, 4Y, 5Y, 6Y	2, 4, 6, 8, 10, 12	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level

Input	Output
nA	nY
L	Н
Н	L

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	$V_1 < -0.5 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V}$ [1]	-	±20	mA
I _{OK}	output clamping current	$V_{O} < -0.5 \text{ V or } V_{O} > V_{CC} + 0.5 \text{ V}$ [1]	-	±50	mA
Io	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[2]	-	500	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SOT402-1 (TSSOP14) package: P_{tot} derates linearly with 7.3 mW/K above 81 °C.

For SOT762-1 (DHVQFN14) package: Ptot derates linearly with 9.6 mW/K above 98 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		2.0	5.0	6.0	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C

^[2] For SOT108-1 (SO14) package: P_{tot} derates linearly with 10.1 mW/K above 100 °C.

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C to	o +85 °C	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
V _{IH}	HIGH-level	V _{CC} = 2.0 V	1.7	1.4	-	1.7	-	1.7	-	V
	input voltage	V _{CC} = 4.5 V	3.6	2.6	-	3.6	-	3.6	-	V
		V _{CC} = 5.5 V	4.8	3.4	-	4.8	-	4.8	-	V
V _{IL}	LOW-level	V _{CC} = 2.0 V	-	0.6	0.3	-	0.3	-	0.3	V
	input voltage	V _{CC} = 4.5 V	-	1.9	0.9	-	0.9	-	0.9	V
		V _{CC} = 5.5 V	-	2.6	1.2	-	1.2	-	1.2	V
V _{OH}	HIGH-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = -20 μA; V _{CC} = 2.0 V	1.8	2.0	-	1.8	-	1.8	-	V
		I _O = -20 μA; V _{CC} = 4.5 V	4.0	4.5	-	4.0	-	4.0	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -20 μA; V _{CC} = 6.0 V	5.5	6.0	-	5.5	-	5.5	-	V
		I_{O} = -5.2 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	V _I = V _{IH} or V _{IL}								
	output voltage	I _O = 20 μA; V _{CC} = 2.0 V	-	0	0.2	-	0.2	-	0.2	V
		I _O = 20 μA; V _{CC} = 4.5 V	-	0	0.5	-	0.5	-	0.5	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 20 μA; V _{CC} = 6.0 V	-	0	0.5	-	0.5	-	0.5	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
II	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0 \text{ V}$	-	-	2	-	20	-	20	μΑ
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); For test circuit see Fig. 7.

Symbol	Parameter	Conditions		25	°C	-40 °C to +85 °C	-40 °C to +125 °C	Unit	
				Тур	Max	Max	Max		
t _{pd}	propagation delay	nA to nY; see Fig. 6	[1]						
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		19	70	90	105	ns	
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		7	14	18	21	ns	
		$V_{CC} = 5.0 \text{ V}; C_L = 15 \text{ pF}$		5	-	-	-	ns	
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		6	12	15	18	ns	
t _t	transition time	see Fig. 6	[2]						
		$V_{CC} = 2.0 \text{ V}; C_L = 50 \text{ pF}$		19	75	95	110	ns	
		$V_{CC} = 4.5 \text{ V}; C_L = 50 \text{ pF}$		7	15	19	22	ns	
		$V_{CC} = 6.0 \text{ V}; C_L = 50 \text{ pF}$		6	13	16	19	ns	
C _{PD}	power dissipation capacitance	per inverter; V _I = GND to V _{CC}	[3]	10	-	-	-	pF	

- t_{pd} is the same as t_{PHL} , t_{PLH} .
- t_t is the same as t_{THL} , t_{TLH} .
- C_{PD} is used to determine the dynamic power dissipation (P_D in μ W). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

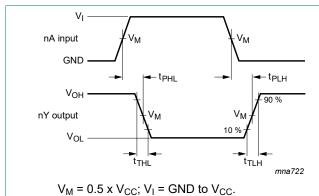
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

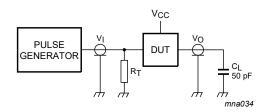
N = number of inputs switching;

 $\Sigma(C_L \times V_{CC})^2 \times f_0$ = sum of outputs.

10.1. Waveform and test circuit



The input (nA) to output (nY) propagation delay Fig. 6. times



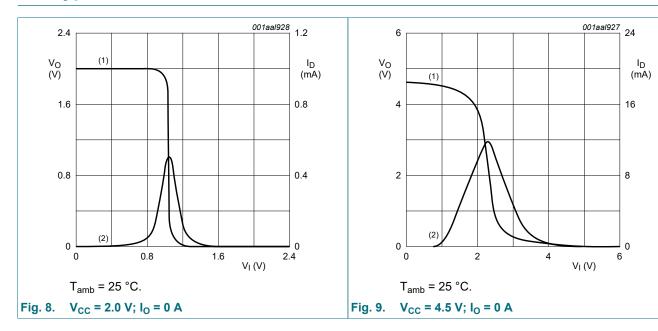
Definitions for test circuit:

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to output impedance Z_{o} of the pulse generator.

Test circuit for measuring switching times Fig. 7.

11. Typical transfer characteristics



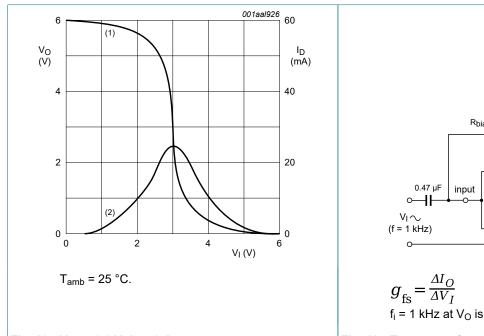


Fig. 10. $V_{CC} = 6.0 \text{ V}$; $I_{O} = 0 \text{ A}$

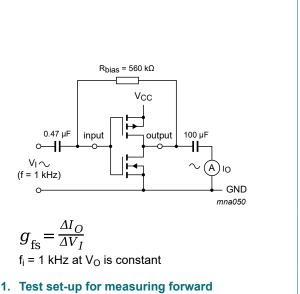
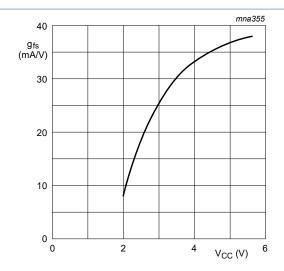


Fig. 11. Test set-up for measuring forward transconductance



 $T_{amb} = 25 \, ^{\circ}C.$

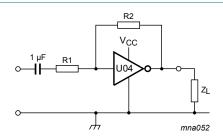
Fig. 12. Typical forward transconductance as a function of the supply voltage

12. Application information

Some applications are:

- Linear amplifier (see <u>Fig. 13</u>)
- · Crystal oscillator design (see Fig. 14)
- Astable multivibrator (see Fig. 15)

Remark: All values given are typical unless otherwise specified.



Maximum $V_{o(p-p)} = V_{CC} - 2.0 \text{ V}$ centered at $0.5V_{CC}$.

$$G_V = -\frac{G_{\text{ol}}}{1 + \frac{R1}{R2}(1 + G_{\text{ol}})}$$

Gol = open loop gain

G_v = voltage gain

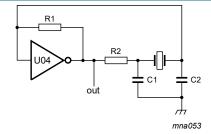
 $R1 \ge 3 \text{ k}\Omega, R2 \le 1 \text{ M}\Omega$

 $Z_L > 10 \text{ k}\Omega$; $G_{ol} = 20 \text{ (typical)}$

 $V_{CC} = 6.0 \text{ V}$

Typical unity gain bandwidth product is 5 MHz.

Fig. 13. Linear amplifier



C1 = 47 pF (typical)

C2 = 33 pF (typical)

R1 = 1 M Ω to 10 M Ω (typical

R2 optimum value depends on the frequency and required stability against changes in V_{CC} or average minimum I_{CC} .

 I_{CC} is typically 5 mA at V_{CC} = 5 V and f_i = 10 MHz.

Fig. 14. Crystal oscillator

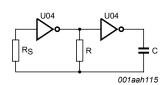
Table 8. External components for resonator (f < 1 MHz)

All values given are typical and must be used as an initial set-up.

Frequency	R1	R2	C1	C2
10 kHz to 15.9 kHz	22 ΜΩ	220 kΩ	56 pF	20 pF
16 kHz to 24.9 kHz	22 ΜΩ	220 kΩ	56 pF	10 pF
25 kHz to 54.9 kHz	22 ΜΩ	100 kΩ	56 pF	10 pF
55 kHz to 129.9 kHz	22 ΜΩ	100 kΩ	47 pF	5 pF
130 kHz to 199.9 kHz	22 ΜΩ	47 kΩ	47 pF	5 pF
200 kHz to 349.9 kHz	10 ΜΩ	47 kΩ	47 pF	5 pF
350 kHz to 600 kHz	10 ΜΩ	47 kΩ	47 pF	5 pF

Table 9. Optimum value for R2

Frequency	R2	Optimum for
3 kHz	2.0 kΩ	minimum required I _{CC}
	8.0 kΩ	minimum influence due to change in V _{CC}
6 kHz	1.0 kΩ	minimum required I _{CC}
	4.7 kΩ	minimum influence by V _{CC}
10 kHz	0.5 kΩ	minimum required I _{CC}
	2.0 kΩ	minimum influence by V _{CC}
14 kHz	0.5 kΩ	minimum required I _{CC}
	1.0 kΩ	minimum influence by V _{CC}
>14 kHz	-	replace R2 by C3 with a typical value of 35 pF

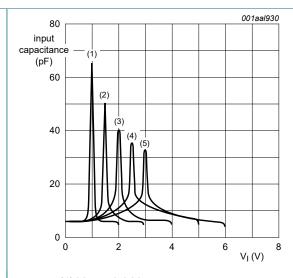


$$f = \frac{1}{T} \approx \frac{1}{2.2 \text{RC}}$$

$$R_S \approx 2 \times R$$

The average I_{CC} (mA) is approximately 3.5 + 0.05 × f (MHz) × C (pF) at V_{CC} = 5.0 V.





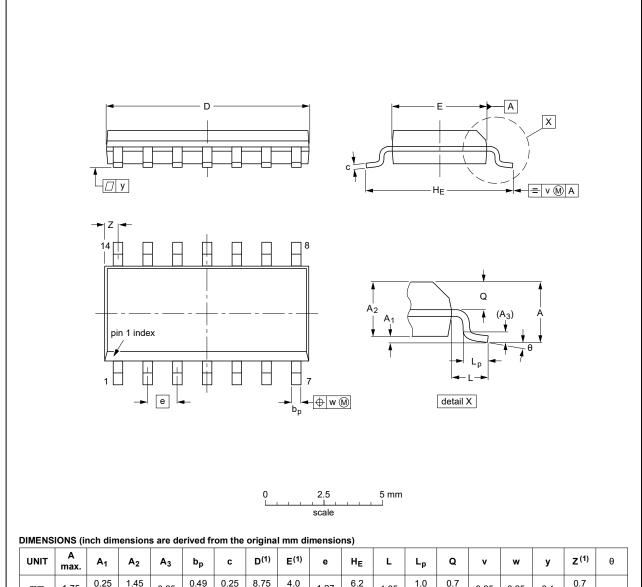
- (1) $V_{CC} = 2.0 \text{ V}$
- (2) $V_{CC} = 3.0 \text{ V}$
- $(3) V_{CC} = 4.0 V$
- $(4) V_{CC} = 5.0 V$
- $(5) V_{CC} = 6.0 V$
- T_{amb} = 25 °C.

Fig. 16. Input capacitance as function of input voltage

13. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

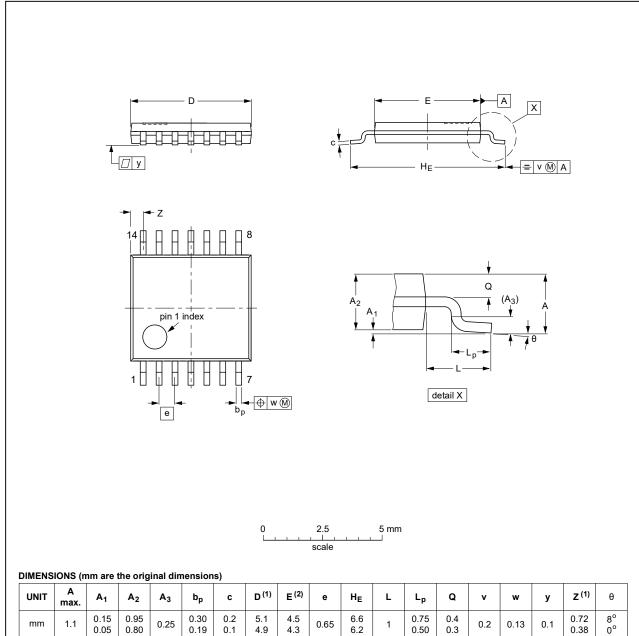
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012				99-12-27 03-02-19

Fig. 17. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E (2)	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT402-1		MO-153				99-12-27 03-02-18

Fig. 18. Package outline SOT402-1 (TSSOP14)

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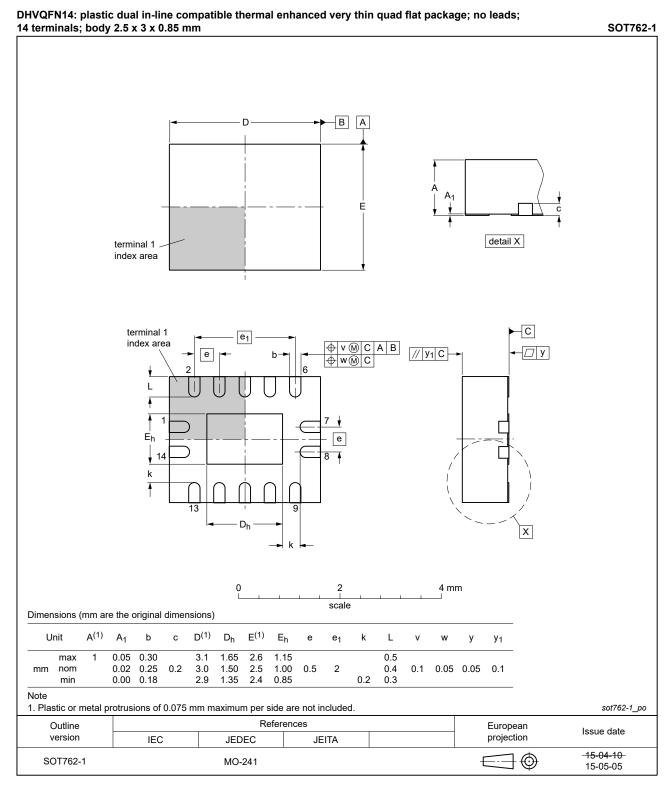


Fig. 19. Package outline SOT762-1 (DHVQFN14)

14. Abbreviations

Table 10. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model

15. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HCU04_Q100 v.3	20200716	Product data sheet	-	74HCU04_Q100 v.2
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Section 2 updated. Section 7: Derating values for P_{tot} total power dissipation have been updated. 			
74HCU04_Q100 v.2	20151022	Product data sheet	-	74HCU04_Q100 v.1
Modifications:	Conditions V _{IL} and V _{IH} corrected (errata).			
74HCU04_Q100 v.1	20130131	Product data sheet	-	-

16. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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Product data sheet

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